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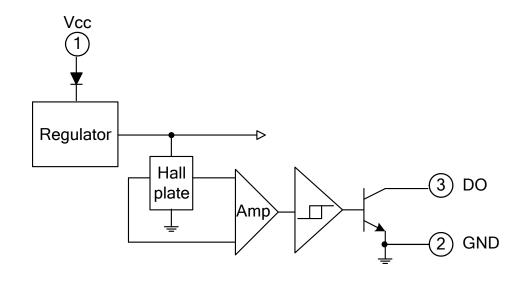


SINGLE OUTPUT HALL EFFECT LATCH

Pin Descriptions

Pin name	P/I/O	Pin#	Description
Vcc	Р	1	Positive power supply
GND	Р	2	Ground
DO	0	3	Digital output

Functional Block Diagram



Absolute Maximum Ratings (T_A = 25°C)

Symbol	Characteristic	Rating	Unit	
V _{cc}	Supply Voltage		20	V
V_{RCC}	Reverse V _{CC} Polarity Voltage		-20	V
В	Magnetic Flux Density	Unlimited		
V_{CE}	Output OFF Voltage	30	V	
P_{D}	Package Power Dissipation	550	mW	
Ic	Output "ON" Current	25	mA	
$T_{J(MAX)}$	Maximum Junction Temperature	150	°C	
T _S	Storage Temperature Range		-65~+150	°C

Recommended Operating Conditions

Symbol	Characteristic	Conditions	Min	Max	Unit
V_{CC}	Supply Voltage	Operating	3.5	20	V
T_A	Operating Ambient Temperature (Note 2)	Operating	-20	85	°C

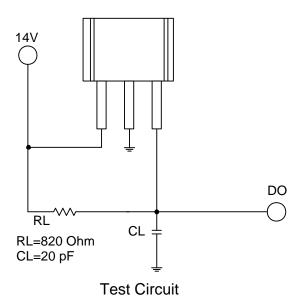
Notes: 2. Shall not exceed P_D and Safety Operation Area.



Electrical Characteristics (T_A = 25°C)

Symbol	Characteristic	Test Conditions	Min	Тур.	Max	Unit
V _{CE} (sat)	Output Saturation Voltage	$V_{CC} = 14V$, $Ic = 20mA$	-	300	700	mV
Icex	Output Leakage Current	$V_{CE} = 14V$, $V_{CC} = 14V$	-	<0.1	10	uA
Icc	Supply Current	V _{CC} = 20V, Output Open	-	5	10	mΑ
tr	Output Rise Time	$V_{CC} = 14V$, $RL = 820\Omega$, $CL = 20pF$	-	0.3	1.5	us
tf	Output Falling Time	$V_{CC} = 14V$, RL = 820 Ω , CL = 20pF	-	0.3	1.5	us

Test Circuit





Magnetic Characteristics (T_A = 25°C, Note 3)

(1mT=10 Gauss)

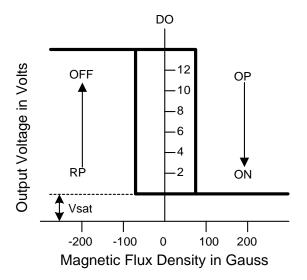
A grade

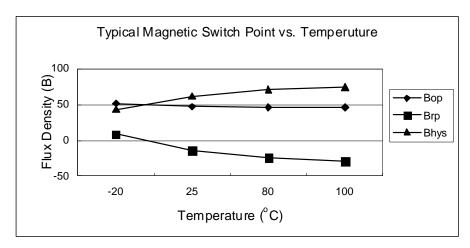
Symbol	Parameter	Min	Тур.	Max	Unit
Bops(south pole to brand side)	Operation Point	5	-	70	Gauss
Brps(south pole to brand side)	Release Point	-70	-	-5	Gauss
Bhy(Bopx - Brpx)	Hysteresis	-	80	-	Gauss

B grade

Symbol	Parameter	Min	Тур.	Max	Unit
Bops(south pole to brand side)	Operation Point	-	-	100	Gauss
Brps(south pole to brand side)	Release Point	-100		-	Gauss
Bhy(Bopx - Brpx)	Hysteresis	-	80	-	Gauss

Notes: 3. Magnetic characteristics may vary with supply voltage, operating temperature and after soldering.



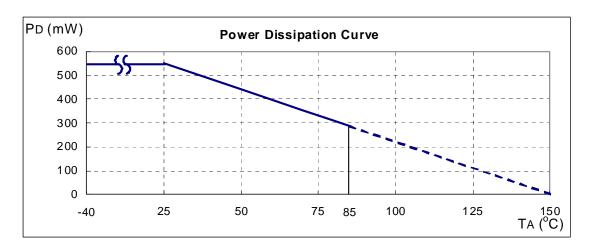




Performance Characteristics

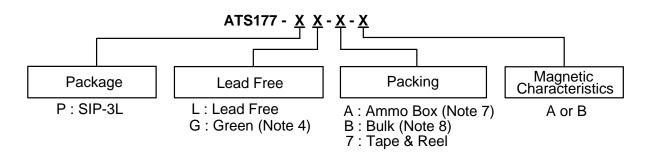
(1) SIP-3L

T _A (°C)	25	50	60	70	80	85	90	95	100
P _D (mW)	550	440	396	352	308	286	264	242	220
T _A (°C)	105	110	115	120	125	130	135	140	150
P _D (mW)	198	176	154	132	110	88	66	44	0





Ordering Information



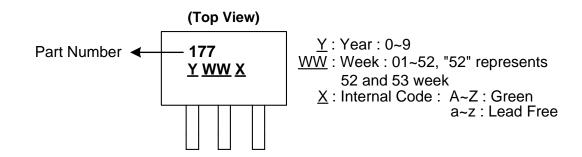
				Tube/Bulk		7" Tape and Reel		Ammo Box			
	Device	Package Code	Packaging (Note 5, 6)		Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix	Magnetic Characteristics	
Pb	ATS177-PL-A-A	Р	SIP-3L	NA	NA	NA	NA	4000/Box	-A	Α	
Pb	ATS177-PL-A-B	Р	SIP-3L	NA	NA	NA	NA	4000/Box	-A	В	
PD,	ATS177-PG-A-A	Р	SIP-3L	NA	NA	NA	NA	4000/Box	-A	Α	
PD,	ATS177-PG-A-B	Р	SIP-3L	NA	NA	NA	NA	4000/Box	-A	В	
Pb	ATS177-PL-B-A	Р	SIP-3L	1000	-B	NA	NA	NA	NA	Α	
Pb	ATS177-PL-B-B	Р	SIP-3L	1000	-B	NA	NA	NA	NA	В	
Pb ,	ATS177-PG-B-A	Р	SIP-3L	1000	-B	NA	NA	NA	NA	Α	
Pb,	ATS177-PG-B-B	Р	SIP-3L	1000	-B	NA	NA	NA	NA	В	

Notes:

- 4. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead_free.html.
- 5. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 6. Reverse taping as shown on Diodes Inc. Surface Mount (SMD) Packaging document AP02007, which can be found on our website http://www.diodes.com/datasheets/ap02007.pdf.
- 7. Ammo Box is for SIP-3L Spread Lead.
- 8. Bulk is for SIP-3L Straight Lead.

Marking Information

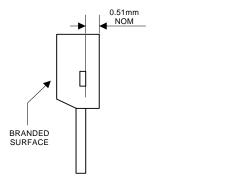
(1) SIP-3L



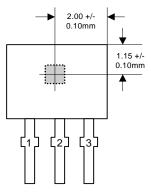


Package Outline Dimensions (All Dimensions in mm)

(1) Package Type: SIP-3L for Bulk pack

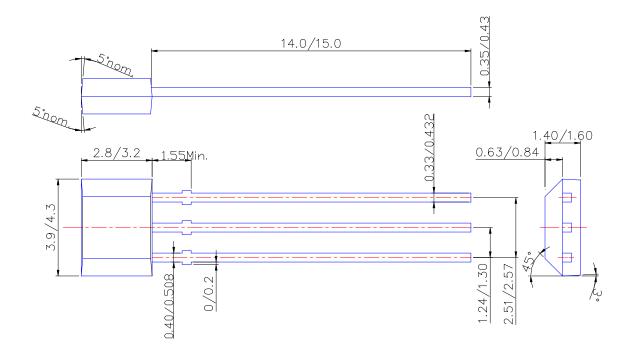


Active Area Depth



Sensor Location

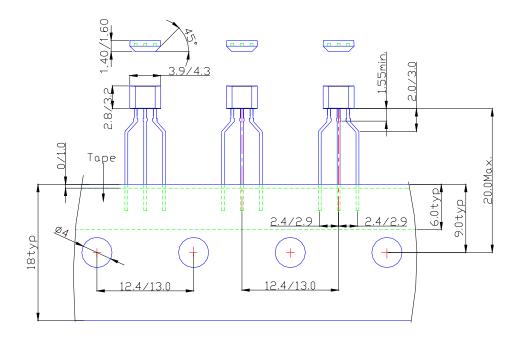
Package Dimension





Package Outline Dimensions (Continued)

(2) Package Type: SIP-3L for Ammo pack





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